

Innovating Energy Technology

http://www.fujielectric.com/products/semiconductor/ **FUJI POWER MOSFET**

Super J-MOS series

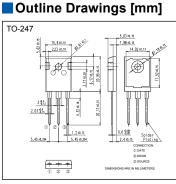
N-Channel enhancement mode power MOSFET

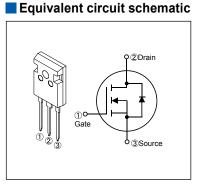
Features

Pb-free lead terminal **RoHS** compliant uses Halogen-free molding compound

Applications

For switching





Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)

Parameter	Symbol	Characteristics	Unit	Remarks
Drain Source Voltage	VDS	600	V	
Drain-Source Voltage	VDSX	600	V	V _{GS} =-30V
Continuous Drain Current		±22	А	Tc=25°C Note*1
Continuous Drain Current	ID	±14	А	Tc=100°C Note*1
Pulsed Drain Current	DP	±66	А	Note*1
Gate-Source Voltage	V _{GS}	±30	V	
Repetitive and Non-Repetitive Maximum Avalanche Current	lar	6.6	А	Note *2
Non-Repetitive Maximum Avalanche Energy	Eas	548.9	mJ	Note *3
Maximum Drain-Source dV/dt	dV _{DS} /dt	50	kV/µs	V _{DS} ≤ 600V
Peak Diode Recovery dV/dt	dV/dt	30	kV/µs	Note *4
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note *5
Maximum Rower Dissinction	P	2.5	W	T _a =25°C
Maximum Power Dissipation	FD	170	vv	Tc=25°C
Operating and Storage Temperature range	Tch	150	°C	
Operating and Storage Temperature range	Tstg	-55 to +150	°C	

Note *1 : Limited by maximum channel temperature. Note *2 : Tch≤150°C, See Fig.1 and Fig.2 Note *3 : Starting Tch=25°C, IAs=4A, L=62.9mH, VpD=60V, RG=50Ω, See Fig.1 and Fig.2

EAs limited by maximum channel temperature and avalanche current. Note *4 : Ir ≤ -I⊳, -di/dt=100A/µs, V⊳s peak ≤ 600V, Tch ≤ 150°C.

Note *5 : IF \leq -ID, dV/dt=30kV/µs, VDs peak \leq 600V, T_{ch} \leq 150°C.

Electrical Characteristics at T_c=25°C (unless otherwise specified) Static Ratings

Parameter	Symbol	Conditions		min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	I₀=250µA V₀s=0V		600	-	-	V
Gate Threshold Voltage	V _{GS(th)}	I₀=500µA V₀s=V₀s		3	4	5	V
Zero Gate Voltage Drain Current	loss	V _{DS} =600V V _{GS} =0V	T _{ch} =25°C	-	-	25	μA
		V _{DS} =480V V _{GS} =0V	T _{ch} =125°C	-	120	-	
Gate-Source Leakage Current	Igss	V _{GS} = ± 30V V _{DS} =0V		-	10	100	nA
Drain-Source On-State Resistance	R _{DS(on)}	I _D =11A V _{GS} =10V		-	0.144	0.17	Ω
Gate resistance	RG	f=1MHz, open drain		-	3.5	-	Ω

Dynamic Ratings

Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Forward Transconductance	g _{fs}	I _D =11A V _{DS} =25V	9.5	19	-	S
Input Capacitance	Ciss	V _{DS} =400V	-	1580	-	
Output Capacitance	Coss	V _{GS} =0V	-	47	-	
Reverse Transfer Capacitance	Crss	f=250kHz	-	3.5	-	
Effective output capacitance, energy related (Note *6)	C _{o(er)}	V _{GS} =0V V _{DS} =0400V	-	125	-	pF
Effective output capacitance, time related (Note *7)	Co(tr)	V _{GS} =0V V _{DS} =0400V I _D =constant	-	415	-	
Turn-On Time	t _{d(on)}	V₀₀=400V, V₀₅=10V I₀=11A, R₀=27Ω See Fig.3 and Fig.4	-	85	-	
Turn-On Time	tr		-	27	-	- ns
Turn-Off Time	t _{d(off)}		-	150	-	
	tr		-	18	-	
Total Gate Charge	Q _G		-	58	-	
Gate-Source Charge	Q _{GS}	Vɒɒ=400V, I₀=22A V₅s=10V See Fig.5	-	17.5	-	nC
Gate-Drain Charge	QGD		-	23.5	-	
Drain-Source crossover Charge	Qsw		-	9	-	1

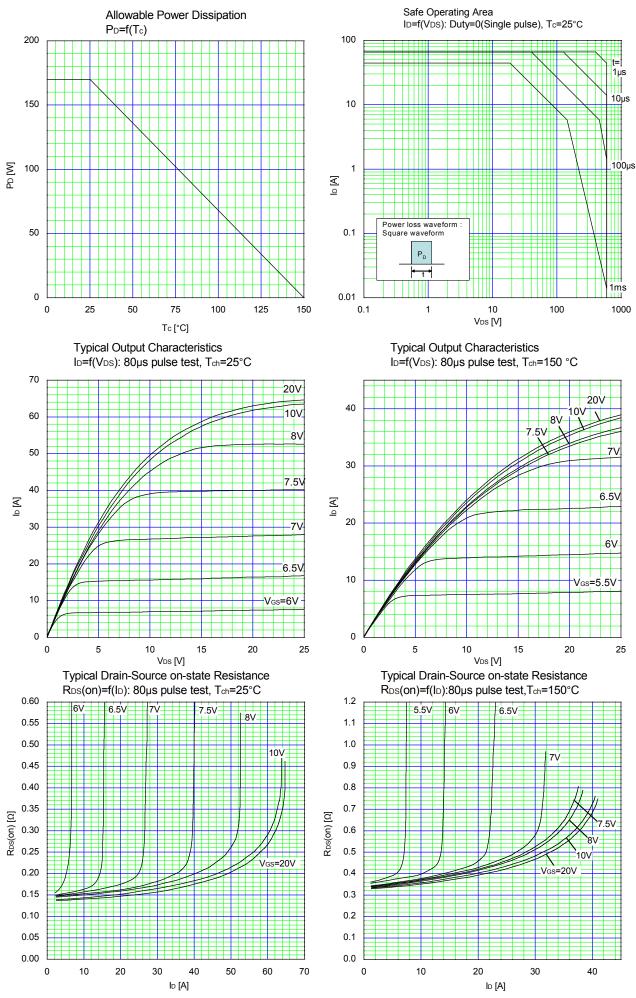
Note *6 : $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V. Note *7 : $C_{o(tr)}$ is a fixed capacitance that gives the same charging times as C_{oss} while V_{DS} is rising from 0 to 400V.

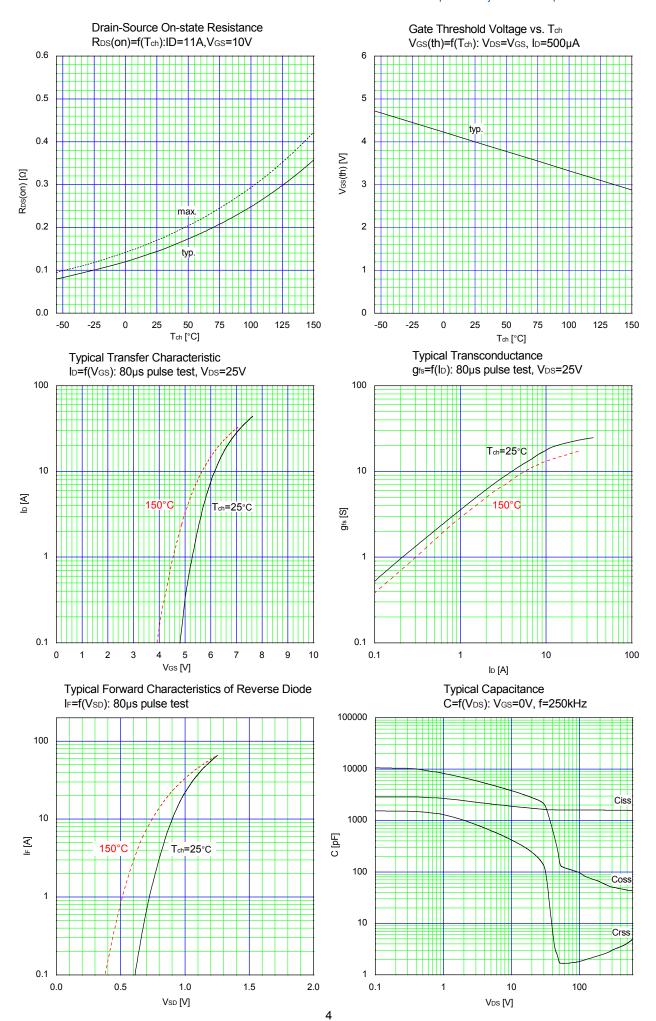
Reverse Diode

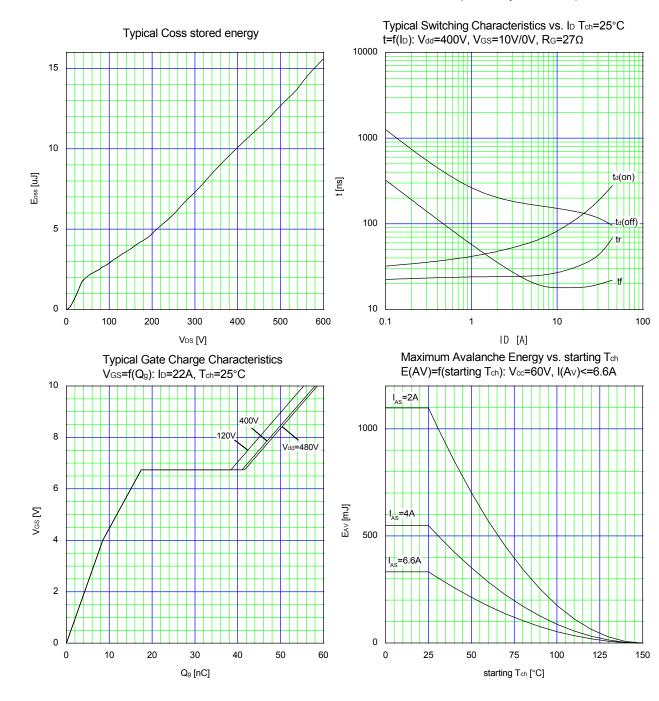
Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Avalanche Capability	lav	L=14mH, T₀+=25°C See Fig.1 and Fig.2	6.6	-	-	А
Diode Forward On-Voltage	V_{SD}	I⊧=22A, V₀s=0V T₀h=25°C	-	1	1.35	V
Reverse Recovery Time	trr	I⊧=22A, V₀₀=400V -di/dt=100A/μs T₀+=25°C See Fig.6 and Fig.7		165	-	ns
Reverse Recovery Charge	Qrr		-	1.1	-	μC
Peak Reverse Recovery Current	Irp		-	13.2	-	А

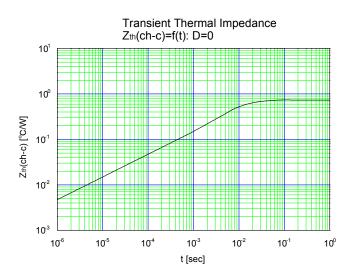
Thermal Resistance

Parameter	Symbol	min.	typ.	max.	Unit
Channel to Case	Rth(ch-c)	-	-	0.74	°C/W
Channel to Ambient	Rth(ch-a)	-	-	50	°C/W









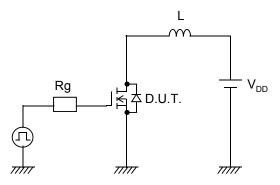


Fig.1 Avalanche Test circuit

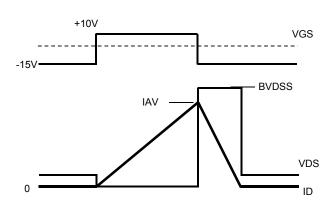
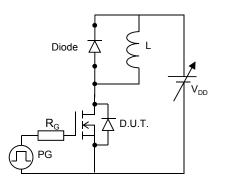


Fig.2 Operating waveforms of Avalanche Test



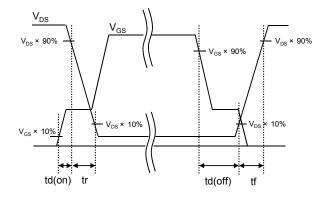


Fig.4 Operating waveform of Switching Test

Fig.3 Switching Test circuit

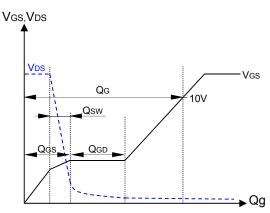


Fig.5 Operating waveform of Gate charge Test

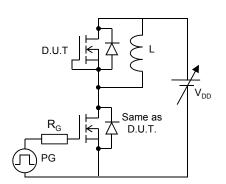


Fig.6 Reverse recovery Test circuit

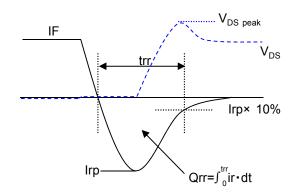
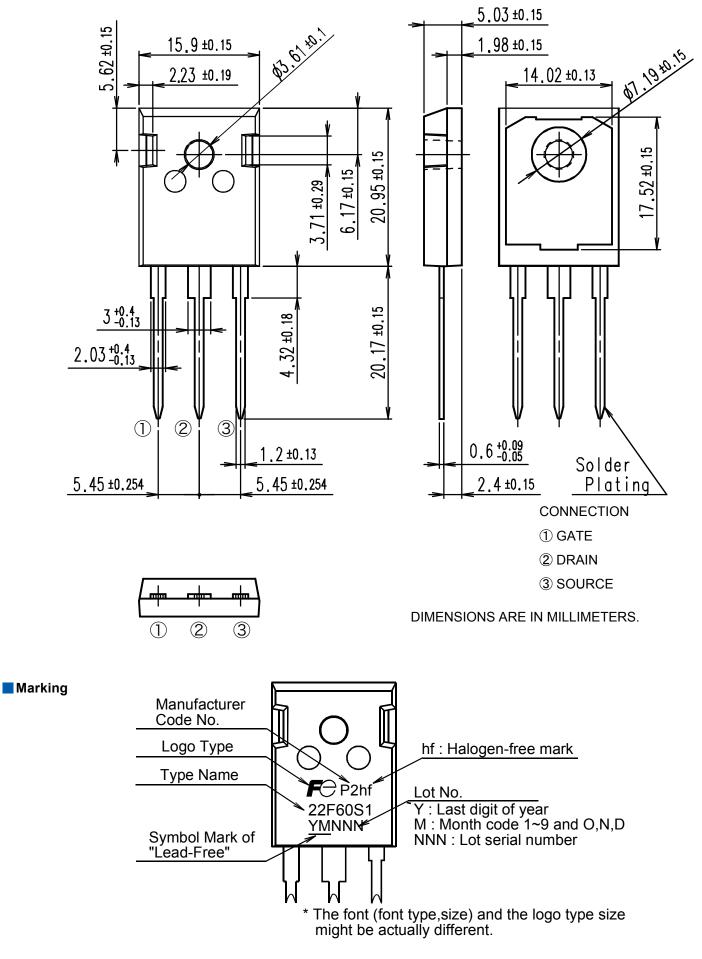


Fig.7 Operating waveform of Reverse recovery Test

FMW22N60S1FDHF

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Outview: TO-247 Package



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